

## GS-R12F

## 2 A DC-DC converter modules

## Features

- MTBF 1 000 000 hours (T<sub>A</sub> = 25 °C)
- 2 A max output current
- 16 V max input voltage
- 1.5 V max drop-out voltage
- Remote logic inhibit/enable
- Synchronization
- Not-latching overload and short circuit protection
- Thermal shutdown
- Fixed or adjustable output
- No heatsink required
- Operating temperature range -25 °C ÷ 85 °C

## Description

The GS-R12F series is a family of high efficiency step down switching voltage regulator, designed to replace linear regulators.

Based on ST L5973 device, these non isclated regulators are suitable for various applications, including telecom, industry, computer and distributed power supply system biaving a wide range input voltage.

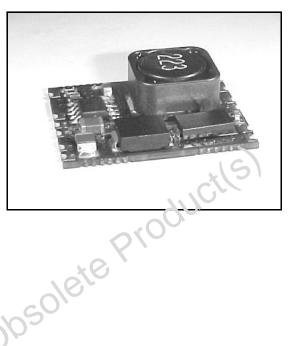


Order codes	Output voltage [V]	Input voltage [V]	Output ripple [mVpp]	Efficiency [%]	Notes
GS-R12F0182.0	1.8 ± 4 %	4.5 ÷ 15	20	72	Fixed output voltage
GS-R12F0252.0	2.5 ± 4 %	4.5 ÷ 15	20	76	Fixed output voltage
GS-R12F0332.0	3.3 ± 4 %	4.5 ÷ 15	20	82	Fixed output voltage
GS-R12F0502.0	5.0 ± 4 %	6.6 ÷ 15	20	85	Fixed output voltage
GS-R12F0002.0	1.235 ÷ 5.5	4.5 ÷ 15	20	68 ÷ 85	Progr. output voltage

February 2008

Table 1.

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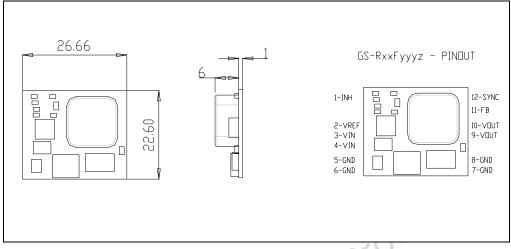
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#### **Pin settings** 1

#### 1.1 **Pin connection**

#### Figure 1. Pin connection and mechanical data (dimensions in mm)



#### 1.2 **Pin description**

1.2	Pin descri	intion	Pro
1.2			lete
	Table 2. Pi	in description	COV-
	Name	Function	Description
	1	INH	A logic high level disables the device. When the pin is open, an internal pull up disables the device
	2	V <sub>ref</sub>	3.3 V reference voltage
	3	Input +	DC input voltage
	4	Input +	DC input voltage
	5	Input GND	Return for input voltage source
	6	Input GND	Return for input voltage source
10	7	Output GND	Return for output voltage source
c Ol	8	Output GND	Return for output voltage source
05	9	V <sub>out</sub>	Regulated power output
0	10	V <sub>out</sub>	Regulated power output
	11	FB	Feedback input, available on adjustable device and on request for additional compensation
	12	Sync	Master/slave synchronization

#### Table 2. **Pin description**



#### **Maximum ratings** 2

#### 2.1 Absolute maximum ratings

#### Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>i</sub>	DC input voltage	16	V
I <sub>out</sub>	Maximum output current	internally limited	
V <sub>1</sub>	INH	-0.3 to V <sub>i</sub>	V
V <sub>12</sub>	Sync	-0.3 to 4	V
V <sub>11</sub>	FB	4	V

#### 2.2 **Thermal data**

Table 4.	Absolute maximum	ratings
	Absolute maximum	raungo

Thermal data Table 4. Absolute maximum ratings				
Symbol	Parameter	Value	Unit	
T <sub>stg</sub>	Storage temperature range	-40 ÷ 105	°C	
T <sub>op</sub>	Operating ambient temperature -25 ÷ 85			
Therma	I de-rating			

#### 2.3 **Thermal de-rating**

#### Table 5. Thermal de-rating for free air condition (all versions)

	Symbol	Parameter	Test condition	Value	Unit
	lo		$V_i$ = 4.5 ÷ 16 V, T <sub>A</sub> = 60 °C (Max)	1.95	
			$V_i = 4.5 \div 16 \text{ V}, \text{ T}_A = 65 ^\circ\text{C} \text{ (Max)}$	1.85	
		Output current	$V_i = 4.5 \div 16 \text{ V}, \text{ T}_A = 70 ^\circ\text{C} \text{ (Max)}$	1.75	А
		Output current	$V_i$ = 4.5 ÷ 16 V, $T_A$ = 75 °C (Max)	1.65	~
10			$V_i = 4.5 \div 16 \text{ V}, \text{ T}_A = 80 ^\circ\text{C} \text{ (Max)}$	1.55	
$cO^{\prime\prime}$			$V_i$ = 4.5 ÷ 16 V, $T_A$ = 85 °C (Max)	1.45	
Opse					



## **3** Electrical characteristics

 $T_A = 25$  °C, unless otherwise specified

utre stability urrent mit nt current nd-by quiescent g frequency	$V_{i} = 12 V, I_{o} = 2 A$ $V_{i} = V_{o} + 1.5 V, I_{o} = 2 A$ $V_{i} = 4.5 \div 16 V$ $V_{i} = 4.5 \div 16 V$ $V_{i} = 12 V, I_{o} = 0 A$ $V_{inh} > 2.2 V$	0	20 TBD 2.5 1.8	35 2 2.5	mVpp mV/°C A A	
urrent mit nt current nd-by quiescent	$V_i = 4.5 \div 16 V$ $V_i = 4.5 \div 16 V$ $V_i = 12 V, I_o = 0 A$	0	2.5		A A	
mit nt current nd-by quiescent	$V_i = 4.5 \div 16 V$ $V_i = 12 V, I_0 = 0 A$	0			A	
nt current nd-by quiescent	$V_i = 12 V, I_o = 0 A$			2.5		
nd-by quiescent			1.8	2.5		
	V <sub>inh</sub> > 2.2 V			-	mA	
; frequency			50	100	μA	
	Switching frequency $V_i = 12 V, I_o = 2 A$		250	275	kHz	
e voltage	$V_i = 4.5 \div 15 V$ $I_{ref} = 0 \div 5 mA$	3.234	3.3	3.366	v	
Short circuit current		8	10	30	mA	
hold voltage	Device ON	210		0.8	V	
INH Infestioid voltage	Device OFF	2.2			V	
< voltage	$V_i = 4.5 \div 15 \text{ V} \text{ I}_0 = 0 \div 2 \text{ A}$	1.22	1.235	1.25	V	
oltage rejection	<u> </u>		TBD		mV/V	
olete Product(s)						
	shold voltage k voltage oltage rejection	belowDevice ONbelowDevice OFFk voltage $V_i = 4.5 \div 15 \ V_i = 0 \div 2 \ A$ oltage rejectionDevice OFF	Device ONbevice OFF2.2k voltage $V_i = 4.5 \div 15 \ V \ I_0 = 0 \div 2 \ A$ oltage rejection1.22	Device ONDevice OFF2.2k voltage $V_i = 4.5 \div 15 V I_0 = 0 \div 2 A$ 1.22oltage rejectionTBD	Device ON0.8Device OFF2.2k voltage $V_i = 4.5 \div 15 V I_0 = 0 \div 2 A$ 1.221.251.25oltage rejectionTBD	

 Table 6.
 Electrical characteristics (all version)



#### **Application information** 4

#### 4.1 Input voltage

The recommended maximum operating DC Input Voltage is 15 V including ripple voltage.

#### 4.2 Reference voltage

No capacitor is required for stability.

#### 4.3 Inhibit function

The inhibit feature allows to put the device in stand-by mode.

With INH pin 1 is higher than 2.2 V the device is disabled and the current consumption is reduced to less than 100  $\mu$ A for V<sub>i</sub> = 15 V.

With INH pin lower than 0.8 V, the device is enabled.

If the INH pin is left floating, an internal pull up ensures that the voltage at the pin reaches the inhibit threshold and the device is disabled. tepri

The pin can be pulled to V<sub>i</sub> to disable the device.

#### 4.4 Multiple units synchronization

Using more than one unit on the same circuit, it is possible to synchronize the switching frequency, connecting all pin 12 together (see Figure 5).

The unit with higher frequency becomes the master.

#### 4.5 **Current limitation**

The device has two current limit protections, pulse by pulse and frequency fold back.

The current is sensed through a resistor and if it reaches the threshold, the on time is reduced and consequently the output voltage, too.

Since the minimum switch ON time (necessary to avoid false overcurrent signal) is not enough to obtain a sufficiently low duty cycle at 250 Hz, the output current could increase again, in strong overcurrent or short circuit conditions.

For this reason the switching frequency is also reduced to keep the inductor current within its maximum threshold limit.

The frequency depends on the feedback voltage.

As the feedback voltage decreases (due to the reduced duty cycle), the switching frequency decrease too.

#### 4.6 Thermal shutdown

The shutdown block generates a signal that turns off the power stage if the temperature of the internal chip goes higher than a fixed internal threshold (150 °C min).

The sensing element of the chip is very close to the PDMOS area, so ensuring an accurate and fast temperature detection.

An hysteresis of approximately 20 °C avoids that the devices turns on and off continuously.

#### 4.7 Output voltage programming (GS-R12F0002.0 only)

The GS-R12F0002.0 output voltage is  $5.54 \text{ V} \pm 4 \%$ , to reduce this value connect a resistor between pin 11 (FB) and pin 10 (V<sub>out</sub>).

The resistor must be located very close to the proper pins, to minimize the injected noise (see Figure 3).

The resistor value is calculated using the following formula:

# $V_{out}$ can be adjusted between 1.235 V (Rv = 0 $\Omega$ ) and 5.54 V (Rv = open) Loop compensation (GS-R12E0002 Q = -1) Loop compensation (GS-R12F0002.0 only) 4.8

If required by particular load conditions, it is possible to change the feedback loop compensation, adding an external capacitor between pin 11 (FB) and pin 10 (Vout), which will act as speed up (see Figure 4). bsolete Product(s)



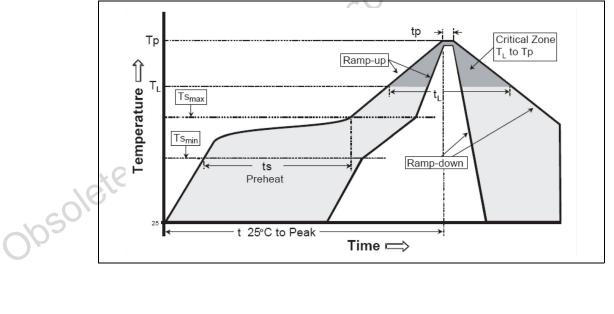
## 4.9 Soldering

Soldering phase has to be execute with care : in order to avoid undesired melting phenomenon, particular attention has to be take on the set up of the peak temperature.

Here following some suggestions for the temperature profile based on IPC/JEDEC J-STD-020C ,July 2004 recommendations.

Profile feature	PB free assembly
Average ramp up rate ( $T_{SMAX}$ to $T_P$ )	3 °C / sec max
Preheat	
Temperature min (T <sub>S</sub> MIN)	150 °C
Temperature max (T <sub>S</sub> MAX)	200 °C
Time $(T_S MIN \text{ to } T_S MAX) (t_S)$	60 – 100 sec
Time maintained above :	
Temperature T <sub>L</sub>	217 °C
Time t <sub>L</sub>	40 – 70 sec
Peak temperature (T <sub>P</sub> )	240 + 0 °C
Time within 5 °C of actual peak temperature ( $t_P$ )	10 – 20 sec
Ramp down rate	6 °C / sec
Time from 25 °C to peak temperature	8 minutes max

### Table 7. Soldering



#### Figure 2. Soldering

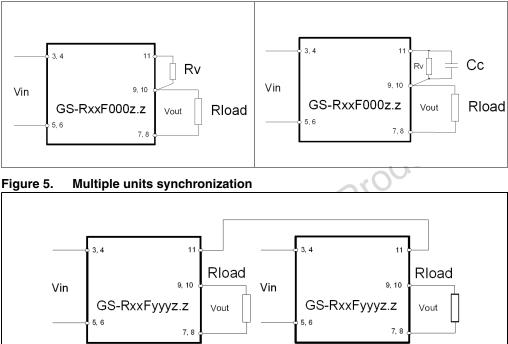
## 5 Additional features and protections

## 5.1 Output overvoltage protection

The overvoltage protection, OVP, is realized by using an internal comparator, whose input is connected to the feedback. It turns off the power stage when the OVP threshold is reached.

This threshold is typically 30 % higher than the feedback voltage.

Figure 3. Output voltage programming Figure 4. Loop compensation



Obsolete Proc

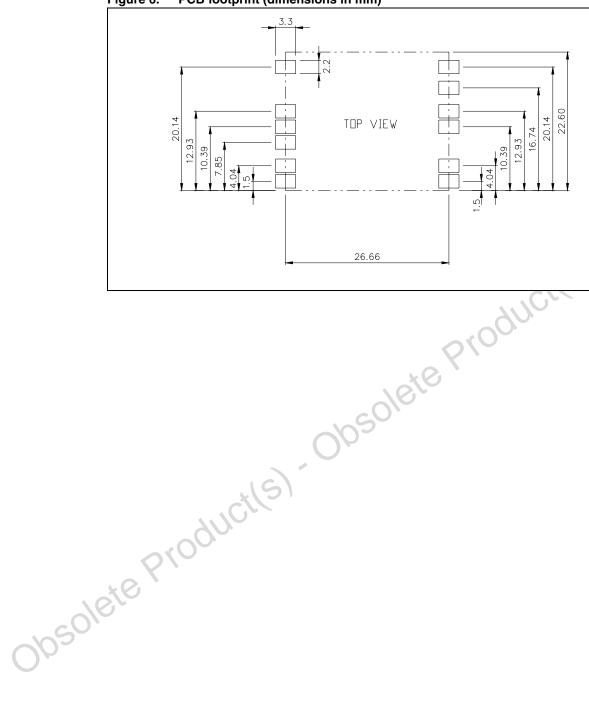


Figure 6. PCB footprint (dimensions in mm)



## 6 Ordering scheme

# GS-R12 F018 2.0 Input voltage 12 = 12 V Output voltage 018 = 1.8 V Obsolete Product(s) - Obsolete Product(s) 025 = 2.5 V

#### Table 8. Ordering information scheme



## 7 Revision history

#### Table 9.Document revision history

Date	Revision	Changes
16-Oct-2006	1	Initial release
25-Feb-2008	2	Added: Section 4.9: Soldering on page 8

obsolete Product(s). Obsolete Product(s)

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